

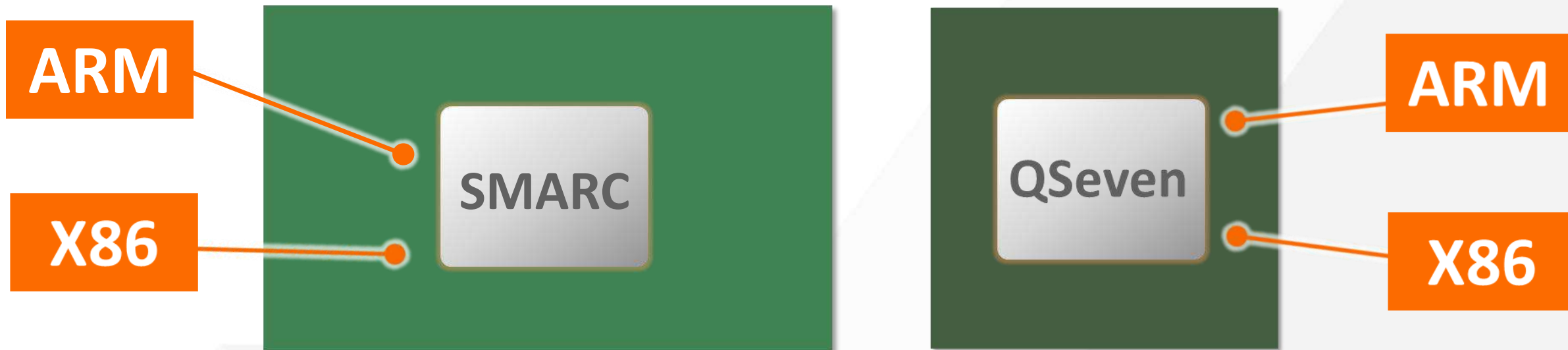


WeLink Solutions, Inc.

# Industrial Module Solutions (SMARC & Qseven)



# Versatile CPUs with AI across X86 and ARM on All of Modules



Intel® Atom™ x7000R/RE®  
processors family



Qualcomm QCS/M Series



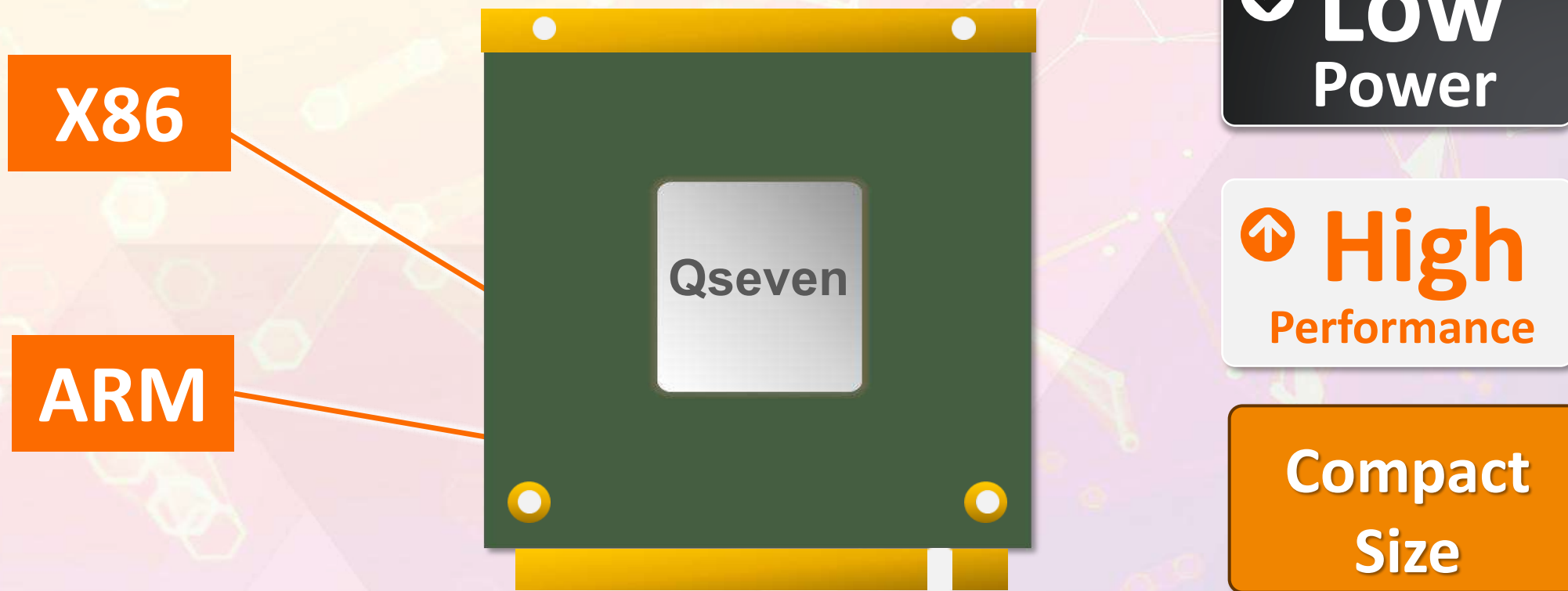
MediaTek Genio 720/520



i.MX 8M Plus

# Qseven Mobility Architecture

Qseven is ideal for traditional embedded applications where a compact, low-power, x86- or ARM-based solution is needed.



# Qseven Module Key Features



## Architecture Flexibility

Fully compatible with x86 and ARM platforms for diverse applications.



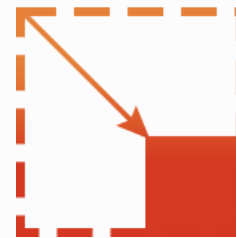
## Compact & Efficient

Measures 70 x 70 mm with low power consumption, ideal for embedded systems.



## Rich I/O Options

Supports USB, PCIe, SATA, HDMI, and more for seamless connectivity.



## Industrial Reliability

Operates in -40°C to +85°C with guaranteed long-term supply.



# WeLink Qseven Modules Eco System

## X86 Module

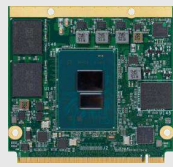
**NEW**



ASL  
MQ7-M31



EHL  
MQ7-M109



ADL  
MQ7-M21



Brasewell  
MQ7-M107



APL  
MQ7-M108

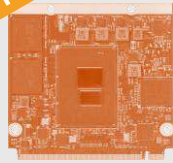
## ARM Module

MTK



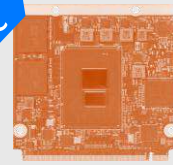
OSM to Qseven converter  
MQ7-G510

MTK



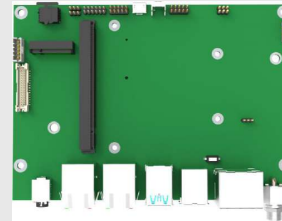
MTK  
MQ7-G720/510

QC



Qualcomm  
MQ7-Q6490

## EVK Carrier



3.5" Embedded  
Board  
MQ7-C350

## Qseven System



# WeLink Qseven Modules

## x86 Architecture

Evolving with  
Different Intel CPU  
Generation



Amston Lake  
WQ7-M31



Alder Lake  
WQ7-M21



Elkhart Lake  
PQ7-M109



Apollo Lake  
PQ7-M108



Braswell  
PQ7-M107

## ARM Architecture

Converting from OSM  
Module to Qseven  
Standard



ARM base  
OSM module



OSM to Q7  
Converter Board



Genio 510  
MQ7-G510



Genio 720  
MQ7-G720

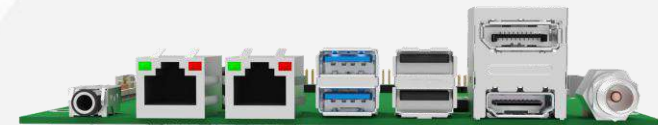
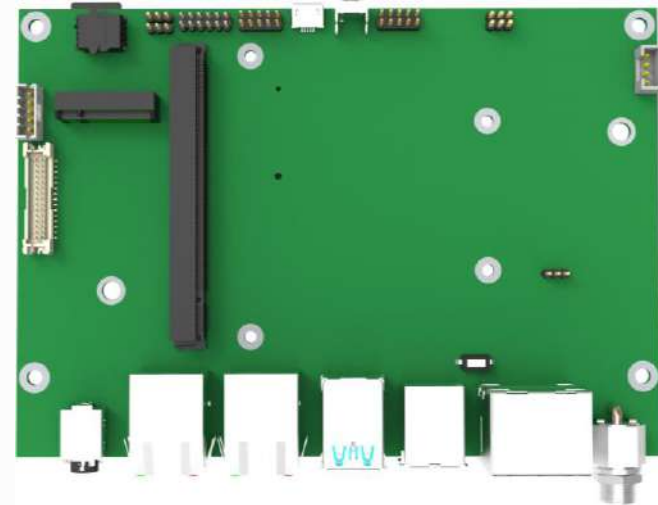
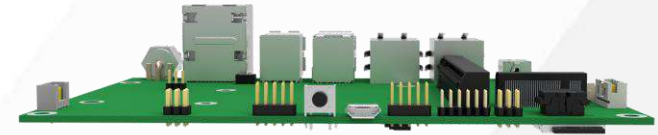
And so on..



# Evaluation Kit

## *Dual-Platform Integration for 3.5" Q7 Carrier Board*

- Dual-Platform Support x86 & ARM
- 3.5" Compact Size with Q7 standard carrier
- Wide Voltage Input & Versatile I/O
- Modular Design for Flexible Expansion
- Industrial-Grade Reliability for Harsh Environments



# Qseven Fan Free Rugged System

*Dual-Platform x86 & ARM supported*

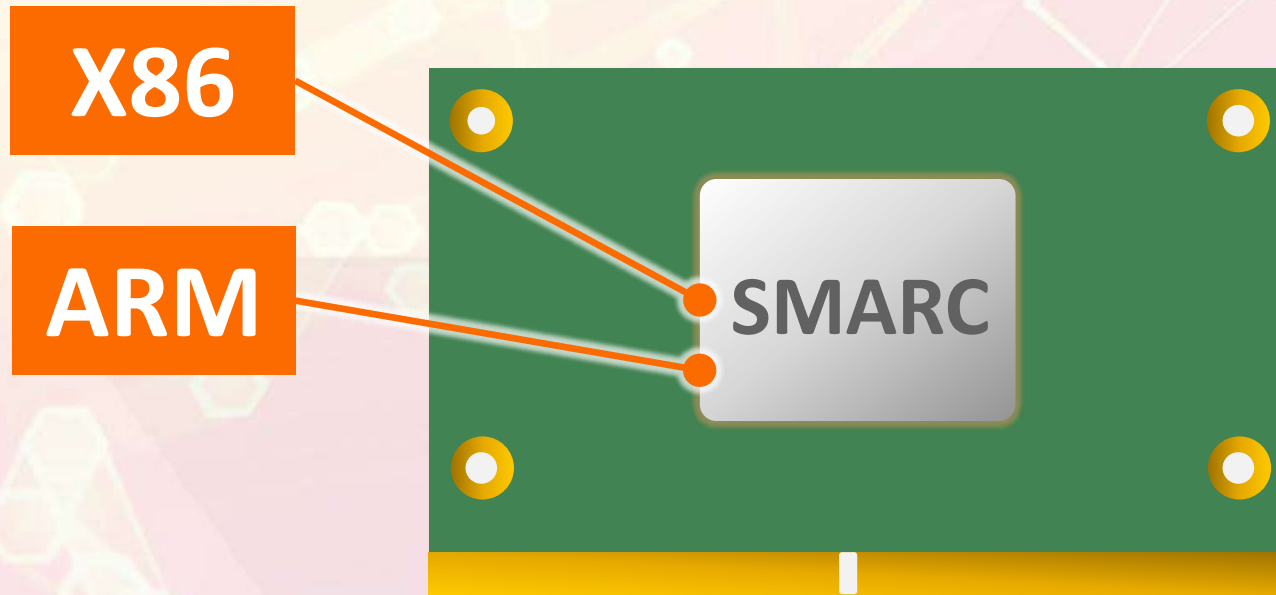
- Fanless Design for Reliable Operation
- Rich I/O & Smart Edge Computing
- High Flexibility & Easy M.2 PCIe Expansion
- Wide Power Input & Temperature Range
- Rugged & IoT-Optimized Platform – A perfect match for IoT applications, featuring robust structure and expandable network gateway capabilities.





# SMARC Smart Mobility Architecture

A versatile small form factor computer module that was defined by the Standardization Group for Embedded Technologies (SGeT).



↓ **Low Power**

↑ **High Performance**

↓ **Low Cost**

# SMARC Key Features



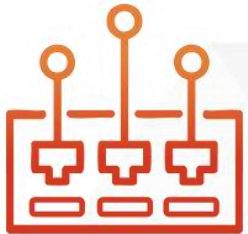
## Architecture Flexibility

Fully compatible with x86 and ARM platforms for diverse applications.



## Compact & Efficient

Measures 82 x 50 mm with ultra-low power consumption, ideal for embedded and IoT applications



## Advanced Multimedia Support

Includes MIPI DSP, audio and camera interfaces for AIoT and smart devices.



## High-Speed & 5G Ready

Supports PCIe, USB3.2, 2.5Gb LAN and 5G-optimized high-speed I/Os.

# WeLink SMARC Modules

## x86 Architecture

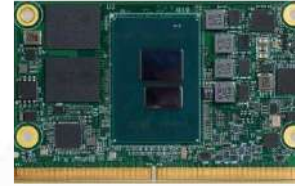
Evolving with  
Different Intel CPU  
Generation



**Amston Lake  
WSC-M32**



**Amston Lake  
WSC-M31**



**Alder Lake  
WSC-M21**



**Elkhart Lake  
PSMC-M1014**



**Apollo Lake  
PSMC-M1013**

## ARM Architecture

A Foundation for  
Computing Everywhere



**MediaTek  
G510/G700  
WSC-M510**



**NXP  
WSC-M841**



**RockChip  
WSC-M3568**



# Where Mostly Targets?

SMARC modules stand out with the rich choice of graphics, camera, sound, network and optional wireless interfaces.



**Robotics**



**Smart Factory**



**Digital Signage**



**Healthcare**



**Transportation**



**KIOSK**





# Connect WeLink Solutions Make Customers Success



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[info@we-link.com.tw](mailto:info@we-link.com.tw)

